

Name of Applicant:

SEE DAI DOO SOCIETY
Application for Educational Assistance to
University and Community College Students

APPLICATION DUE FRIDAY JUNE 9, 2023

Last Name	First Name	Middle Name	Chinese Name

Residence Address _____

City _____ State _____ Zip Code _____ Telephone No. () _____

Male ____ Female ____ Place of Birth _____

E-mail address _____ Hawaii Resident since _____ (year)

Have you received a SDDS Scholarship in the past? _____

If yes, list all year(s) you received a SDDS scholarship _____

Current school attending _____

INFORMATION ABOUT APPLICANT'S FAMILY

Name of your Ancestor who came from the See Dai Doo Geographical District of Zhongshan, Guangdong Province, China, and his or her Ancestral Village.

Chinese Name of Ancestor

Ancestral Village

Father's Last Name	First and Middle Name	Father's Chinese Name	Father's Ancestral Village
Mother's Last Name	First and Middle Name	Mother's Chinese Name	Mother's Ancestral Village

Please write or type legibly.

Name of Applicant:

Parents' Address where educational assistance is to be sent:

City _____ State _____ Zip Code _____

We, the undersigned, certify the information provided to be true and accurate, including the ancestral village.

Applicant's signature _____ Date _____

Father's signature _____ Date _____

Mother's signature _____ Date _____

ACKNOWLEDGEMENT AND CONSENT: Applicant is responsible for obtaining and submitting all materials and completing all questions by the deadline. All materials submitted will be kept confidential and become the property of the See Dai Doo Society. Applicant agrees to abide by the decision of the SDDS Education Committee. Applicant further gives permission for the release of information about the award by the See Dai Doo Society to be published in the SDDS newsletter and website or other media.

Applicant Signature _____ Date _____
(mm/dd/yyyy)

To the applicant and the parents/guardian of the applicant: Please sign and acknowledge the following.
"I HEREBY GIVE MY PERMISSION FOR THE RELEASE OF INFORMATION ABOUT THE EDUCATIONAL AWARD BY SEE DAI DOO SOCIETY TO BE PUBLISHED IN THE SDDS NEWSLETTER AND WEBSITE OR OTHER MEDIA. I ALSO ALLOW THE SEE DAI DOO SOCIETY TO PUBLISH MY ESSAY OR EXCERPTS OF MY ESSAY IN THE SEE DAI DOO NEWSLETTER AND WEBSITE OR OTHER MEDIA."

Full name of applicant _____ (please print)

Applicant's Signature _____ Date _____

Print Name(s) of Parent(s) _____

Signature(s) of Parent/Guardian if Applicant is under the age of 18. _____ Date _____
(mm/dd/yyyy)

Please write or type legibly.

Name of Applicant:

High School Attended _____ Graduation Date _____ Cumulative GPA _____

College/University attending in Fall of 2023 _____

College Class Level: Fr. So. Jr. Sr. Dates Semesters Begin: Fall _____ Spring _____ Other _____

College Academic Year 2022 GPA: _____ Credits completed _____ Tuition per year _____

Academic Major _____ Credit Hrs. Fall _____ Spring _____

Degree sought (AA, AS, BA, BS, etc.): _____ Expected College Graduation Date: _____

Name of person who will provide your letter of recommendation:

Name _____

Title and Institution/Company _____

Email _____

PLEASE EMAIL ALL MATERIALS BEFORE Friday JUNE 9, 2023 TO SDDSScholarship@gmail.com.

**In addition, please mail this completed 3-page application form with the original signatures to the
SEE DAI DOO SOCIETY (ATTN: SCHOLARSHIP), 1300 PALI HIGHWAY, HONOLULU, HI 96813**

_____ Check here if your transcript will be mailed to the See Dai Doo Society instead of electronically.

Refer to "Application Instructions for Educational Assistance to University and Community College Students" for further requirements of your application. If you have any questions, please email:

SDDSScholarship@gmail.com

SELECTION of AWARDEES:

All recipients receiving awards will be honored and introduced to the Directors at a See Dai Doo Society meeting on Wednesday, August 2, 2023. Recipients who are unable to attend must be represented by a parent, guardian or grandparent. If you are selected, please make every effort to attend this meeting which may be held by Zoom. Decisions will be made by July 15, 2023 and an email/letter will be sent to you with more details. Successful applicants are expected to send in a photo for the newsletter, as well as proof of payment of tuition and class enrollments prior to the release of funds.

Please write or type legibly.